Atomistic simulation of transport properties of non-graphitic armchair nanotubes and effect of Stone-Wales defects

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Abstract—In this work, we study the carrier transport properties of three non-graphitic armchair nanotubes (of Silicene, Germanene and Phosphorene) under an empirical tight binding (ETB) – non-equilibrium Green’s function (NEGF) approach. The electronic properties are studied with extended Hückel theory, while phonon calculations are carried out with Stillinger-Weber classical potentials in ATK. The impact of Stone-Wales (SW) defects in electron and phonon transport properties of such tubes is also investigated. Our simulations show Silicene and Germanene nanotubes to offer much better electrical conduction than phosphorene NTs. The carrier transport and charge density around the SW defect site is found to be affected more significantly in phosphorene nanotubes. Suppression of phonon transmission with introduction of defect is observed for all the cases. The overall results show a good possibility of defect engineered tailoring of electrical and thermal properties of these nanotubes.

Keywords—nanotubes, defect, ETB, NEGF, phonon

I. INTRODUCTION

Nanotubes of non-graphitic 2D materials such as Silicene, Germanene, MoS2 and Phosphorene are beginning to generate significant interest of late owing to their mechanical, optical and electronic properties [1]-[3]. Also for nanoelectronics applications such tubes hold good promise as nanotube FETs or interconnect materials. The atomistic simulation of the electronic transport properties of such nanotubes (NTs) could therefore be of considerable importance for device applications. In this work we investigate by empirical tight binding (ETB) methods carrier transport (device density of states (DDOS), carrier densities, I-V characteristics), phonon transmission and thermoelectric properties of armchair nanotubes of Silicene, Germanene and Phosphorene. As the honeycomb structure of the 2D lattice of Silicene, Germanene and Phosphorene are susceptible to Stone-Wales (SW) defects [3,4], we further study their impact on the carrier transport properties of these NTs.

II. METHODOLOGY

The armchair nanotubes (of diameters ~ 2 nm) are considered consisting of a central (device) region connected to left and right electrodes extending to reservoirs far away (where the bias is applied). For the ETB study we use a 1x1x50 Monkhorst-Pack k-grid [5] on the device supercell and employ the extended Hückel theory (EHT). EHT is chosen for the simulations owing to its computational efficiency for simulating large device supercells, as compared to density functional theory (DFT) and good estimation of electronic band-gaps. [7] We use the Hoffman basis sets for Si, Ge and P with vacuum energy level of 0 eV in all three cases. [6,7] The Wolfsburg weighting scheme is used in our extended Hückel theory calculations. Mesh cutoff energy of 10 Ha is used with the Pulay-mixer algorithm as iteration control parameter and tolerance value of 10⁻⁵ Ha. [8]
the left and right contacts respectively, \( \eta_{L,R} \) are the left and right contact chemical potentials respectively. \( g_{sv} \) are the spin degeneracy and valley degeneracy respectively, \( E_{sv} \) the energy eigenvalue.

The calculations for phonons is carried out with Stillinger-Weber classical potentials (for Si, Ge NTs) and EAM_NiP_Sheng classical potential (for P NTs) \([10,11]\) using the frozen phonon method which is a supercell based small displacement calculation. \([6,12]\) 180 small displacements each of 0.01 Å value are applied in the c direction of the device supercell for calculating forces and the dynamical matrix of the system, which is used in calculating the phonon properties. The contribution of both electrons and phonons are taken into account for calculating the heat current \( I_T \) due to voltage/temperature difference between the electrodes, and thus the thermal conductance is evaluated as \([13,14]\)

\[
\kappa = \frac{dI_T}{dT} \quad (2)
\]

thermoelectric figure of merit \( (ZT) \) is calculated as \([13]\)

\[
ZT = \frac{\varphi S^2 T}{\kappa} \quad (3)
\]

In (3), \( \varphi \) is the electrical conductance, \( S \) the Seebeck coefficient, \( T \) is the temperature.

### III. RESULTS AND DISCUSSIONS

From the projected device DOS (Fig. 2), the density of up and down spin conduction channels seem symmetric. Larger number of states are seen below the fermi level (\( \epsilon_F = 0 \)), than above it for Si and Ge NTs. States are further away from the fermi level in case of phosphorene NT. With the incorporation of Stone-Wales defect, there seems a marked increase in magnitude as well as broadening of device DOS, for Si and Ge NTs. For phosphorene NTs, the broadening is present but in slightly lesser amount, although peaks are significantly strengthened more than Si and Ge NTs. A direct band gap of \( \sim 0.32 \) eV and \( 0.18 \) eV is calculated for perfect Si and Ge NTs, for P NTs this is indirect gap of about \( 1.79 \) eV. The effect of these defects are more prominently observable in terms of electron density projections (shown in Fig. 3). For the perfect NTs, the projected carrier density along the c-axis remains almost fixed around values \( n_e \sim 305.5 \text{Å}^{-2} \) for Si NT, \( n_e \sim 289.5 \text{Å}^{-2} \) for Ge NT and \( n_e \sim 455.5 \text{Å}^{-2} \) for P NT. In presence of SW defects, there is a sharp undulation in \( n_e \) around the region where the defect is created. At the center of the defect site, a dip in \( n_e \) by \( \sim 10 \text{Å}^{-2} \), is seen for Si and Ge NTs, for P NT this dip is about \( 20 \text{Å}^{-2} \). In the sites adjacent to the SW defect a rise in \( n_e \) is observed (\( \sim 5 \text{Å}^{-2} \) for Si and Ge NTs, and \( \sim 10 \text{Å}^{-2} \) for P NT). This shows a stronger defect induced carrier density redistribution for phosphorene NT. This could be owing to stronger changes in the s and the p orbital contribution of the atoms around the defect site to the overall density of states in P NTs, as compared to that in Si and Ge NTs.

The current voltage (I-V) characteristics are shown in Fig. 4. Si and Ge NTs show much higher currents in the range of \( \sim 300 - 350 \) \( \mu \)A, compared to P NTs (\( I \sim 1-8 \) \( \mu \)A). This can be explained by the near metallic behavior of Si and Ge NTs with smaller band gaps and lesser carrier effective masses compared to P NTs. In presence of SW defects the current in P NT seems to be enhanced greatly after \( V=2 \) Volts, as the strong DDOS peaks (Fig. 2) around -1eV and less, start to fall within the bias window with increasing voltage. For Si and Ge the current enhancement is not that significant in presence of defect states.
The phonon transmission spectra (Fig. 5), shows multiple peaks in $T_{ph}$ for Si and Ge NTs and a single less sharper (in comparison) peak for P NT. It also indicates that a considerable quenching of phonon transmission in presence of SW defects for all the three NTs. In Fig. 6 we show the thermal conductance, considering the contributions of both electrons and phonons to the heat current. The simulation results at 300 K, show Si and Ge NTs to have a higher value of $\kappa_{e+ph}$ as compared to P NT. In case of the Si and Ge NTs, the heat transport coefficient is electronic conduction dominated for a larger range of 0 - 3 eV than P NTs where this range is about 0.75 - 3 eV. Si and Ge NTs also show a peak of the coefficient at about 1.1 and 1.2 eV respectively, the value of this peak being slightly higher for Si (~13.75 nW/K) than Ge (~11.9 nW/K). For P NT a plateau is observed for the maximum $\kappa_{e+ph}$ ~4.55 nW/K, in the range of 1.75 – 3 eV. In the presence of the SW defects, $\kappa$ is significantly reduced to ~40-50% of their original (perfect) values. A constriction of the electronic conduction dominated range is also observed, which is most prominent for P NTs.

The calculated thermoelectric parameters namely conductance ($\rho_e$), Peltier coefficient ($\Pi$) and Seebeck coefficient ($\Sigma$) at $T$=300K, are listed in Table -I. It is notable that there is a change of sign in the Seebeck and Peltier coefficients in Ge NT upon the introduction of defect. This suggests a change from electron dominated to hole dominated heat conduction with SW defect in Ge NT. For P NT the heat conduction is hole dominated for both perfect and defect cases, while for Si NT its electron dominated for both.

### TABLE I. CALCULATED THERMOELECTRIC PARAMETERS ($T$=300K)

<table>
<thead>
<tr>
<th>Material</th>
<th>Thermoelectric parameters</th>
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<tbody>
<tr>
<td></td>
<td>$\rho_e$ ($\Omega$) $\Pi$ (V) $\Sigma$ (V/K)</td>
</tr>
<tr>
<td>Si NT perfect</td>
<td>1.970x10^-7 -3.425x10^-3 -1.442x10^-5</td>
</tr>
<tr>
<td>Si NT SW defect</td>
<td>1.336x10^-7 -1.106x10^-3 -3.685x10^-4</td>
</tr>
<tr>
<td>Ge NT perfect</td>
<td>4.240x10^-4 -7.627x10^-3 -2.542x10^-4</td>
</tr>
<tr>
<td>Ge NT SW defect</td>
<td>2.391x10^-4 5.320x10^-1 1.775x10^-7</td>
</tr>
<tr>
<td>P NT perfect</td>
<td>3.802x10^-17 7.771x10^-4 2.590x10^-3</td>
</tr>
<tr>
<td>P NT SW defect</td>
<td>3.590x10^-19 8.037x10^-3 2.676x10^-3</td>
</tr>
</tbody>
</table>

IV. CONCLUSION

From the simulations it is seen Silicene and Germanene NTs show more metallic behavior than phosphorene NTs and conduct higher currents. However phosphorene NTs undergo more significant carrier density redistribution around the Stone-Wales defects. The enhancement of current, quenching of phonon transmission, and significant variations in thermoelectric parameters indicate significant possibility of defect engineered tailoring of electrical and thermal transport properties in these armchair nanotubes.

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